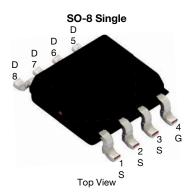
Vishay Siliconix

# N-Channel 40 V (D-S) MOSFET



PRODUCT SUMMARY						
V <sub>DS</sub> (V)	40					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0045					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.0060					
Q <sub>g</sub> typ. (nC)	29					
I <sub>D</sub> (A) <sup>a</sup>	27.2					
Configuration	Single					

### **FEATURES**

- TrenchFET® power MOSFET
- 100 % R<sub>g</sub> and UIS tested

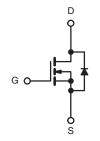




RoHS

### **APPLICATIONS**

• DC/DC conversion



N-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and halogen-free	Si4122DY-T1-GE3			

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	40	
Gate-source voltage		V <sub>GS</sub>	± 25	V
	T <sub>C</sub> = 25 °C		27.2	
Ocation and ducin assument (T. 150 °C)	T <sub>C</sub> = 70 °C		20.1	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	19.2 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		15.3 <sup>b, c</sup>	
Pulsed drain current		I <sub>DM</sub>	70	A
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		5.4	
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.7 <sup>b, c</sup>	
Single pulse avalanche current	. 0.1!!	I <sub>AS</sub>	40	
Avalanche energy	L = 0.1 mH	E <sub>AS</sub>	80	mJ
Maximum power dissipation	T <sub>C</sub> = 25 °C		6	
	T <sub>C</sub> = 70 °C		3.3	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3 b, c	W
	T <sub>A</sub> = 70 °C		1.9 <sup>b, c</sup>	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT			
Maximum junction-to-ambient b, d	t ≤ 10 s	R <sub>thJA</sub>	33	42	°C/W		
Maximum junction-to-foot (drain)	Steady state	$R_{thJF}$	16	21	C/VV		

### Notes

- a. Based on  $T_C = 25$  °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. Maximum under steady state conditions is 85  $^{\circ}\text{C/W}$



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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	43	-		
V <sub>GS(th)</sub> temperature coefficient	ΔV <sub>GS(th)</sub> /T <sub>J</sub>	I <sub>D</sub> = 250 μA	-	-6	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = 250 \ \mu A$	1.2	-	2.5	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$	-	-	± 100	nA	
<b>-</b>	I <sub>DSS</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V	-	-	1	μА	
Zero gate voltage drain current		V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	10		
On-state drain current a	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30	-	-	Α	
Drain actives on state registeres a	_	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A	-	0.0036	0.0045	_	
Drain-source on-state resistance a	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A	-	0.0048	0.0060	Ω	
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A	-	65	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	4200	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	475	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	225	-		
Total gate charge	Qg	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	-	62	95	nC	
			-	29	44		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	12	-		
Gate-drain charge	Q <sub>gd</sub>		-	9	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz	0.2	1	2	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	42	70		
Rise time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_{L} = 2 \Omega$	-	34	60		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	45	75		
Fall time	t <sub>f</sub>		-	28	45		
Turn-on delay time	t <sub>d(on)</sub>		-	14	25	ns	
Rise time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_{L} = 2 \Omega$	-	10	20		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	35	60		
Fall time	t <sub>f</sub>		-	9	18		
<b>Drain-Source Body Diode Characterist</b>	ics						
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	5.4	^	
Pulse diode forward current <sup>a</sup>	I <sub>SM</sub>		-	-	70	Α	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 3 A	-	0.72	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	31	50	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 5 A, di/dt = 100 A/μs,	-	31	50	nC	
Reverse recovery fall time	t <sub>a</sub>	T <sub>J</sub> = 25 °C	-	18	-		
Reverse recovery rise time	t <sub>b</sub>	1	_	13	_	ns	

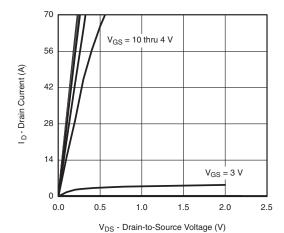
### Notes

- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

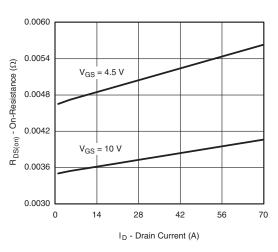
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



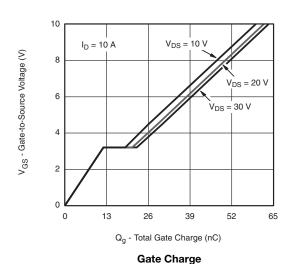
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

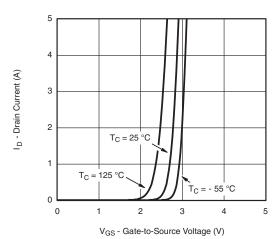


### **Output Characteristics**

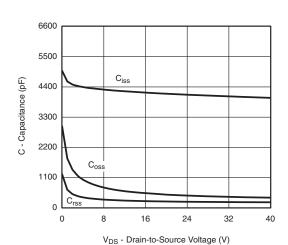


### On-Resistance vs. Drain Current and Gate Voltage

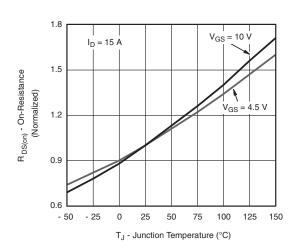




**Transfer Characteristics** 



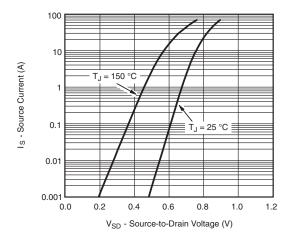
Capacitance



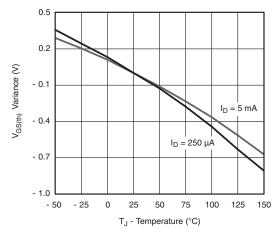
On-Resistance vs. Junction Temperature



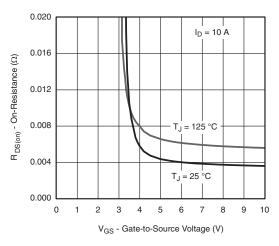
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



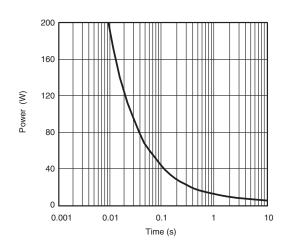
### Source-Drain Diode Forward Voltage



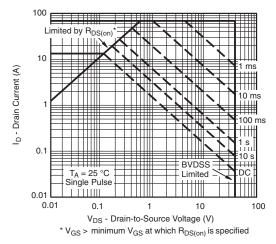
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power

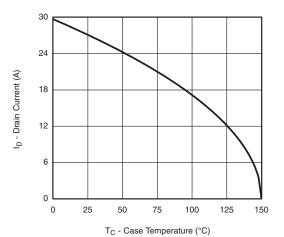


Safe Operating Area, Junction-to-Ambient

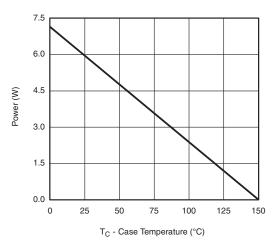
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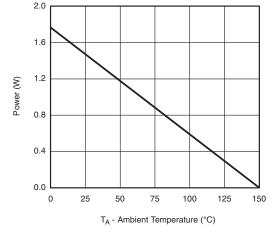


### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



### Current Derating a





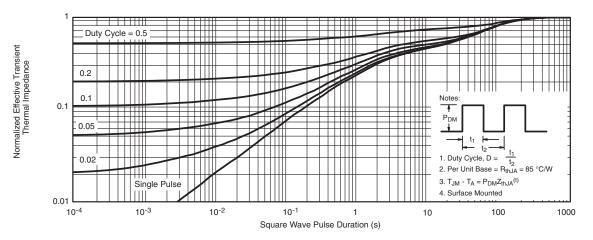
Power Derating, Junction-to-Foot

Power, Junction-to-Ambient

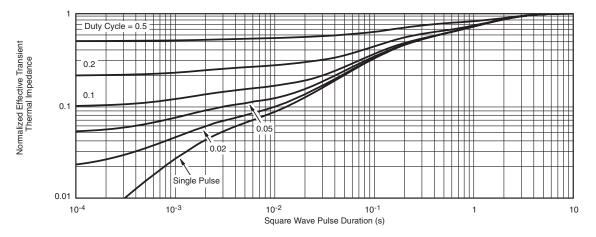
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06

# LON NOTE



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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